Rev. 1.2, 16-Nov-2023

For technical questions, contact: sensorstechsupport@vishay.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT

ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000

Vishay Semiconductors

A Small Package Proximity Sensor With a VCSEL, Low Idle Current, I²C Interface, and Smart Dual Slave Address



- Package type: surface-mount
- Dimensions (L x W x H in mm): 2.0 x 1.0 x 0.5
- Integrated modules: vertical-cavity surfaceemitting laser (VCSEL), photodiode, and application-specific integrated circuit (ASIC)
- 1.8 V rated power supply and I²C bus
- Low power consumption with 5 µA idle current
- A small package allows a design with a small window size
- Smart dual I²C slave address in one package
- Immunity to red glow (940 nm VCSEL)
- Programmable I_{VCSEL} sink current
- Intelligent cancellation to reduce cross talk phenomenon
- Smart persistence scheme to reduce measurement response time
- Interrupt functionality
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Smartphones and true wireless stereo (TWS) earbuds
- VR / AR headsets and smart glasses
- Smartwatches
- Touchless button / dispensing

PRODUCT SUMMARY										
PART NUMBER	OPERATING RANGE (mm)	OPERATING VOLTAGE RANGE (V)	AGE RANGE VOLTAGE RANGE		OUTPUT CODE	ADC RESOLUTION PROXIMITY / AMBIENT LIGHT				
VCNL36828P	200	1.65 to 2.00	1.2 to 3.6	20	12 bit / 16 bit, l ² C	16 bit / -				

ORDERING INFORMATION									
ORDERING CODE	PACKAGING	VOLUME ⁽¹⁾	REMARKS						
VCNL36828P	Tape and reel	MOQ: 5000 pcs, 5000 pcs/reel	2.0 mm x 1.0 mm x 0.5 mm						

Note

⁽¹⁾ MOQ: minimum order quantity



LINKS TO ADDITIONAL RESOURCES



DESCRIPTION

The VCNL36828P is a fully integrated proximity sensor. It combines a vertical-cavity surface-emitting laser (VCSEL), photodiode, and application-specific integrated circuit (ASIC) within a single package. The VCNL36828P has been developed for proximity detection applications that require a dual slave address, low power consumption, small package size, small window size, and short range operation. In addition, given the typical rated supply voltage of 1.8 V to reduce power consumption, the sensor is intended for battery-powered applications.



VCNL36828P





RoHS COMPLIANT

HALOGEN

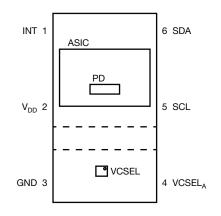
FREE GREEN

(5-2008)





PIN DEFINITION



PIN DESCRIPTION	PIN DESCRIPTION										
PIN NUMBER	PIN NAME	TYPE	DESCRIPTION								
1	INT	O (open drain)	Interrupt								
2	V _{DD}	I	Supply voltage								
3	GND	I	Ground								
4	VCSELA	I	VCSEL anode								
5	SCL (1)	I / O (open drain)	I ² C serial clock								
6	SDA ⁽¹⁾	I / O (open drain)	I ² C serial data								

Note

⁽¹⁾ Pin 5 (SCL) and pin 6 (SDA) can be swapped to change the slave address from 0x60 to 0x51; please refer to Table 1

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)										
PARAMETER	TEST CONDITION	SYMBOL	MIN.	MAX.	UNIT					
Supply voltage		V _{DD}	0	2	V					
Ambient temperature range		T _{amb}	-40	+85	°C					
Storage temperature range		T _{stg}	-40	+100	°C					



VCNL36828P

Vishay Semiconductors

BASIC CHARACTERISTICS	BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)											
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT						
ASIC				•		•						
Supply voltage		V _{DD}	1.65	1.80	2.00	V						
	Shutdown state; light condition = dark; $V_{DD} = 1.8 V$		-	1	-							
Supply current ⁽¹⁾	Idle state ⁽²⁾ ; $V_{DD} = 1.8 V$	I _{DD}	-	5	-	μA						
Γ	Active state ⁽²⁾ ; V _{DD} = 1.8 V		-	5 1.80 2.0 1 - 5 - 330 - 2 - 1.8 3.6 - 0.5 2 - 1.92 -	-							
I ² C supply voltage		V _{PULL UP}	1.2	1.8	3.6	V						
I ² C signal input, logic high	V _{DD} = 1.8 V	V _{IH}	1	-	-	V						
I ² C signal input, logic low	V _{DD} = 1.8 V	VIL	-	-	0.5	V						
VCSEL												
Supply voltage of the VCSEL ⁽³⁾		V _{VCSEL}	2.62	-	3.60	V						
Forward voltage	I _F = 9 mA	V _F	-	1.92	-	V						
Forward current		I _F	7	-	20	mA						
Angle of half intensity		φ	-	± 4.5	-	0						
Peak wavelength	I _F = 9 mA	λρ	-	940	-	nm						
Spectral bandwidth	I _F = 9 mA	Δλ	-	3	-	nm						
PHOTODIODE				•		•						
Angle of holf consistivity	X-axis ⁽⁴⁾		-	± 60	-	0						
Angle of half sensitivity	Y-axis ⁽⁴⁾	φ -		± 45	-							
Peak sensitivity wavelength		λρ	-	850	-	nm						

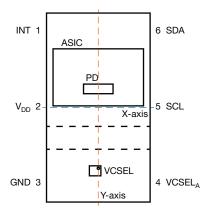
Notes

⁽¹⁾ Actual current consumption depends on the register settings. Please refer to the application note on the current consumption

(2) Excluding VCSEL driving current

⁽³⁾ V_{VCSEL} should at least match the minimum required supply voltage for the VCSEL V_{VCSEL, min}. Please refer to the V_{VCSEL, min} table

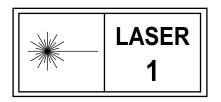
⁽⁴⁾ Cross section of the package



V _{VCSEL} , MIN.	-											
PS_CURRENT (I _F)	7 mA	9 mA	11 mA	12 mA	15 mA	17 mA	19 mA	20 mA				
V _{VCSEL, min.}	2.62 V	2.74 V	2.86 V	2.91 V	3.08 V	3.19 V	3.3 V	3.36 V				
V _{VCSEL, max.}		3.6 V										



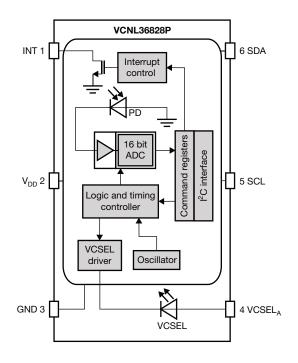
LASER CLASS



Note

• Product specification with IEC / EN 60825-1:2014 compliance and above label

BLOCK DIAGRAM





DADAMETED	SYMBOL	STANDA	RD MODE	FAST		
PARAMETER	STMBUL	MIN.	MAX.	MIN.	MAX.	UNIT
Clock frequency	f _(I2CCLK)	10	100	10	400	kHz
Bus free time between start and stop condition	t _(BUF)	4.7	-	1.3	-	μs
Hold time after (repeated) start condition; after this period, the first clock is generated	t _(HDSTA)	4.0	-	0.6	-	μs
Repeated start condition setup time	t _(SUSTA)	4.7	-	0.6	-	μs
Stop condition setup time	t _(SUSTO)	4.0	-	0.6	-	μs
Data hold time	t _(HDDAT)	0	3450	0	900	ns
Data setup time	t _(SUDAT)	250	-	100	-	ns
I ² C clock (SCL) low period	t _(LOW)	4.7	-	1.3	-	μs
I ² C clock (SCL) high period	t _(HIGH)	4.0	-	0.6	-	μs
Clock / data fall time	t _(f)	-	300	-	300	ns
Clock / data rise time	t _(r)	-	1000	-	300	ns

Note

• Data based on standard I²C protocol requirement, not tested in production

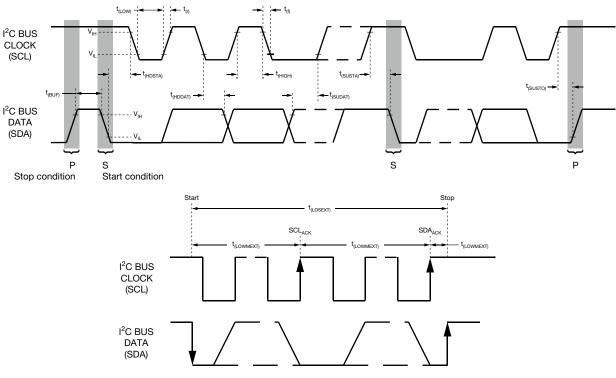


Fig. 1 - I²C Bus Timing Diagram

www.vishay.com

Vishay Semiconductors

PARAMETER TIMING INFORMATION

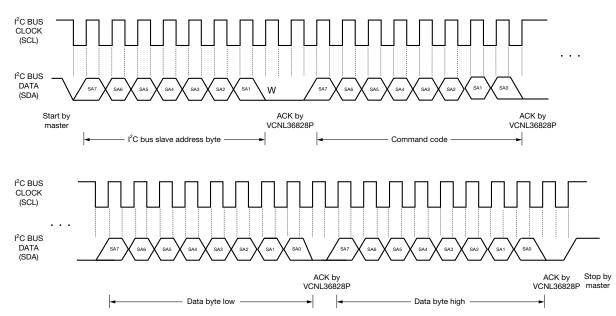


Fig. 2 - I²C Bus Timing for Sending Word Command Format

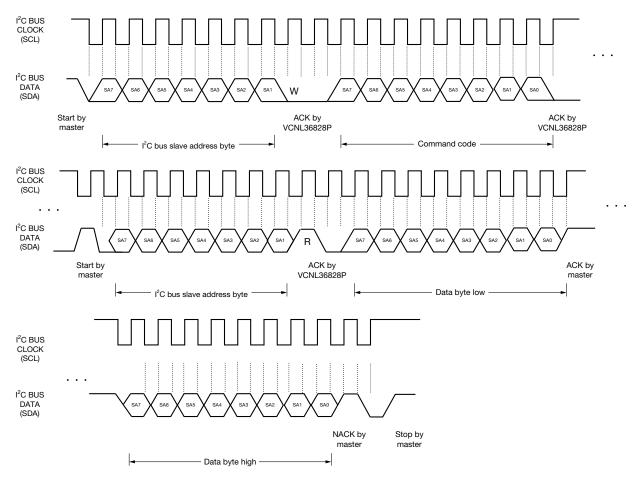


Fig. 3 - I²C Bus Timing for Receiving Word Command Format

For technical questions, contact: <u>sensorstechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



TYPICAL PERFORMANCE CHARACTERISTICS ($T_{amb} = 25 \text{ °C}$, unless otherwise specified)

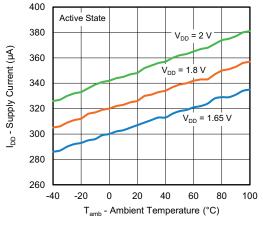


Fig. 4 - Supply Current vs. Ambient Temperature

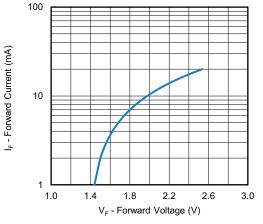


Fig. 5 - Forward Current vs. Forward Voltage of the VCSEL

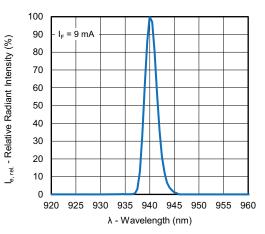


Fig. 7 - Relative Radiant Intensity vs. Wavelength of the VCSEL

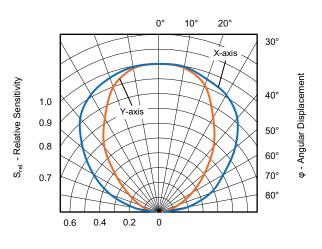
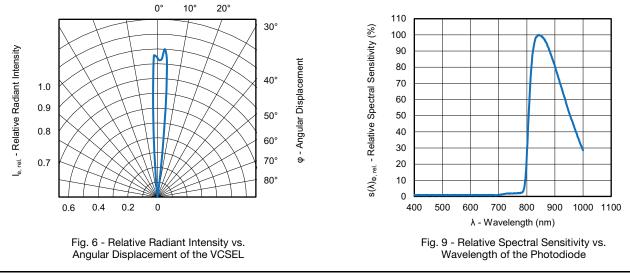


Fig. 8 - Relative Sensitivity vs. Angular Displacement of the Photodiode

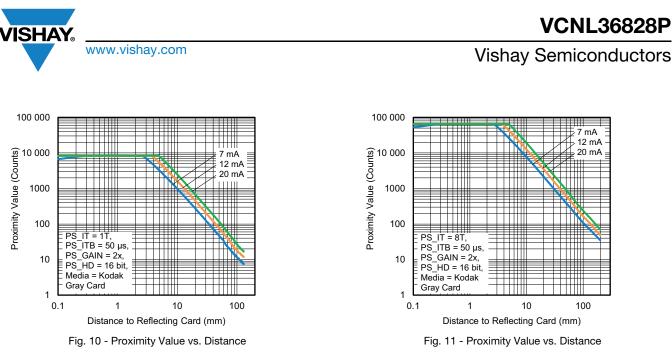


Rev. 1.2, 16-Nov-2023

7

Document Number: 80306

For technical questions, contact: <u>sensorstechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



APPLICATION INFORMATION

Slave Address Selection

The VCNL36828P supports a smart dual slave address where the designer can change the slave address by swapping the SCL and SDA pins, as shown in Table 1.

TABLE 1	TABLE 1 - SLAVE ADDRESS TABLE										
PIN 5	PIN 6	7 BIT SLAVE ADDRESS	8 BIT SLAVE ADDRESS (WRITE)	8 BIT SLAVE ADDRESS (READ)							
SCL	SDA	0x60	0xC0	0xC1							
SDA	SCL	0x51	0xA2	0xA3							

A smart dual slave address provides the flexibility for the designer to connect two devices from two different slave addresses on the same I²C bus. Besides that, the two slave address options allow designers to select a different slave address if one is used by the other slave devices on the same I^2C bus in a single device application.

Application Circuit With a Single Device - Slave Address 0x60

Fig. 12 shows an application circuit example with a single device. As described in Table 1, when pins 5 and 6 are connected to the clock and data signal from the microcontroller, as shown in Fig. 12, they will then be configured as an SCL pin and SDA pin, respectively. The 7 bit slave address option of 0x60 will be automatically selected.

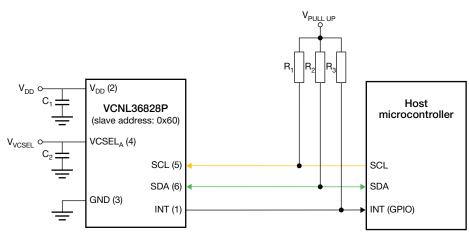


Fig. 12 - Application Circuit Example for a Single VCNL36828P - Slave Address 0x60



Application Circuit With a Single Device - Slave Address 0x51

On the other hand, when pins 5 and 6 are connected to the data and clock signal from the microcontroller, as shown in Fig. 13, they will then be configured as an SDA pin and SCL pin, respectively. The 7 bit slave address option of 0x51 will be automatically selected.

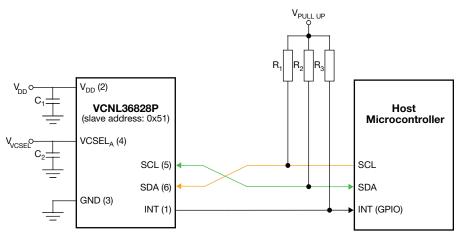


Fig. 13 - Application Circuit Example for a Single VCNL36828P - Slave Address 0x51

Table 2 shows the required values and the explanation for the individual application circuit parameters.

TABLE 2 - A	PPLICATION C	CIRCUIT PARAMETERS
CIRCUIT PARAMETER	VALUE	DESCRIPTION
V _{DD}	1.65 V to 2.00 V	A stable power supply such as a low dropout regulator or a switching regulator is required; the power supply isolation can be further improved with a decoupling capacitor C_1
V _{VCSEL}	2.62 V to 3.60 V	A stable power supply such as a low dropout regulator or a switching regulator that can supply an adequate amount of power (max. VCSEL pulse driving current of 20 mA) is required; the power supply isolation can be further improved with a decoupling capacitor C ₂ ; the minimum voltage depends on the selected driving current of the VCSEL; please refer to Table V _{VCSEL, min.} for reference
V _{PULL UP}	1.2 V to 3.6 V	A stable power supply such as a low dropout regulator or a switching regulator is required; a voltage level shifter is required if the I ² C bus voltage from the microcontroller is higher than 3.6 V
C ₁ - C ₄	100 nF to 1 µF	Decoupling capacitors are recommended to reduce the noise in the supply voltage
R ₁ - R ₂	2.2 kΩ to 4.7 kΩ	Pull-up resistors within the range of 2.2 k Ω to 4.7 k Ω are recommended; any increase in bus capacitance or resistance will increase the logic high transition time
R ₃	4.7 k Ω to 22 k Ω	Pull-up resistor within the range of 4.7 k Ω to 22 k Ω is recommended



Application Circuit With a Smart Dual Slave Address

Fig. 14 shows an application circuit example with a smart dual slave address. By swapping the SCL and SDA pins of the second device, as shown in Table 1, the designer can change the 7 bit slave address of the VCNL36828P. This provides the flexibility for the designer to connect two devices from two different slave addresses on the same I²C bus.

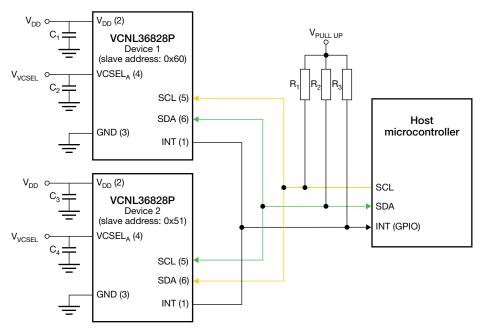


Fig. 14 - Application Circuit Example for Two VCNL36828Ps - Smart Dual Slave Address

I²C Write and Read Protocol

The communication with the VCNL36828P can be performed via I²C. The I²C write and read protocol when communicating with the proximity sensor is shown in Fig. 15.

Sen	d byte \rightarrow write comr	nand	to \	/CNL36828P													
1	7	1	1	8	1		8	1			8	1	1				
S	Slave address	Wr	А	Command code	А		Data byte low	А	Data byte high		Data byte high		Ρ				
Rec	eive byte $ ightarrow$ read da	ta fro	m V	CNL36828P													
1	7	1	1	8	1	1	7		1	1	8			1	8	1	1
S	Slave address	Wr	А	Command code	А	S	Slave address		Rd	А	Data byte	low		А	Data byte high	Ν	Р
P = A =	start condition stop condition acknowledge not acknowledge			Host action VCNL36828P response													

Fig. 15 - I²C Write and Read Protocol

It is imperative that only the restart condition for the I²C read is implemented instead of the stop and restart condition.

VCNL36828P



Vishay Semiconductors

Function Description

COMMAND CODE	DATA BYTE LOW / HIGH	REGISTER NAME	DEFAULT VALUE	FUNCTION	ACCESS				
	1	PS CONF1 L	0x00	Internal calibration setting					
	L	PS_CONFI_L	UXUU	Switch the sensor on / off					
0x00				High dynamic range setting					
	н	PS_CONF1_H	0x00	Persistence setting]				
				Interrupt setting					
	L			Measurement period setting					
		PS_CONF2_L	0x00	Signal strength setting (Integration time and multi-pulse)					
0x01				High gain setting					
0.01				Sensitivity of the ADC setting					
	н	H PS_CONF2_H		Internal crosstalk cancellation setting	Write				
			VCSEL driving current setting						
	L		PS CONF3 L 0x00 Sensor mode setting		and read				
0x02	L	F3_CONF3_L	Active force mode trigger setting						
0702	н		PS CONF3 H 0x00 Short measurement period setting						
	11	1.9_00101.9_11	Sunlight cancellation setting						
0x03	L	PS_THDL_L 0x00		Low threshold interrupt value setting (low byte)					
0703	Н	PS_THDL_H	0x00	Low threshold interrupt value setting (high byte)					
0x04	L	PS_THDH_L	0x00	High threshold interrupt value setting (low byte)					
0,04	Н	PS_THDH_H	0x00	High threshold interrupt value setting (high byte)					
0x05	L	PS_CANC_L	0x00	Offset count cancellation value setting (low byte)					
0,000	Н	PS_CANC_H	0x00	Offset count cancellation value setting (high byte)					
0xF8	L	PS_DATA_L	0x00	Proximity output data (low byte)					
	Н	PS_DATA_H	0x00	Proximity output data (high byte)					
0xF9	L	Reserved	0x00 - 0xFF	Reserved					
071.9	Н	INT_FLAG	0x00	Interrupt flag	Read only				
0xFA	L	VCNL36828P_ID_L	0x28 / 0x29	Device ID Slave address: 0x60; ID = 0x28 Slave address: 0x51; ID = 0x29					
	Н	VCNL36828P_ID_H	0x01	Device ID	1				

Notes

• All of the reserved registers are used for internal test. These values must be kept constant

(1) The default ID depends on the connection of the SCL and SDA pins on the VCNL36828P with the SCL and SDA pins on the host MCU. If pins 5 and 6 on the VCNL36828P are connected to the SCL and SDA pins on the host, the default value will be 0x28. On the other hand, if pins 5 and 6 on the VCNL36828P are connected to the SDA and SCL pins on the host, the default value will be 0x29. Please refer to Fig. 13





Command Register Format

TABLE 4	TABLE 4 - REGISTER NAME: PS_CONF1_L											
Bit 7	Bit 6	Bit 5 Bit 4 Bit 3 Bit 2 Bit 1										
PS_CAL	Reserved PS_ON											
COMMAND C	COMMAND CODE 0x00											
Bit N	lame	Fund	ction	Bit	Value	ription						
PS CAL		Enable / disable the	internal calibration	7	0x0 (0b0)	Disable (default)						
F3_	CAL		internal calibration	7	0x1 (0b1)	Enable						
Rese	erved	Rese	Reserved 6 : 1 0x00 (0b000000)				Should be kept default					
PS ON		Switch the sensor on / off		0	0x0 (0b0)		urn off the sensor hutdown) (default)					
					0x1 (0b1)	Turn on the sensor						

TABLE 5	- REGISTER	R NAME: PS_CON	NF1_H				
Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
Reserved	PS_HD	PS_SP_INT	PS_SMART_PERS	PS_I	PERS	PS_	INT
COMMAND (CODE					0x00	
Bit N	lame	Fund	ction	Bit	Value	Desci	ription
Rese	erved	Rese	erved	15	0x0 (0b0)	Should be	kept default
De	HD	Enable / disable high c	lynamic range (12 bit /	14	0x0 (0b0)	Disable (12	bit) (default)
гэ <u></u>	_חח	16 bit) ADC output setting		14	0x1 (0b1)	Enable	(16 bit)
	P INT	Enable / disable the	13	0x0 (0b0)	Disable (default)		
P5_5	P_INT	mode inter	13	0x1 (0b1)	Ena	able	
		Enable / disable the	e smart persistence	12	0x0 (0b0)	Disable (default)	
F3_SIVIAI	RT_PERS	setting when the inter	12	0x1 (0b1)	Enable		
				11 10	0x0 (0b00)	1 time (default)	
	PERS		onsecutive threshold		0x1 (0b01)	2 times	
F3_F	ENO	inter	ecessary to trigger rupt	11 : 10	0x2 (0b10)	3 times	
			·		0x3 (0b11)	4 times	
					0x0 (0b00)	Interrupt dis	able (default)
PS	INT	Set the interrup	ot mode setting	9:8	0x1 (0b01)	Logic high	/ low mode
10_			st mode betting	0.0	0x3 (0b11)		ich high / low ld event

VCNL36828P



www.vishay.com

Vishay Semiconductors

TABLE 6 -	REGISTER N	IAME: PS_CO	NF2_L				
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
PS_PI	ERIOD	PS	_IT	PS_	MPS	PS_ITB	PS_GAIN
COMMAND CO	DDE					0x01	
Bit N	Bit Name		ction	Bit	Value	Descr	iption
					0x0 (0b00)	,	translates into ent/s (default)
	ERIOD	Set the measu	romant pariod	7:6	0x1 (0b01)		translates into rements/s
F3_FI		Set the measu	irement penoa	7.0	0x2 (0b10)	200 ms, which translates into 5 measurements/s	
					0x3 (0b11)		translates into rements/s
		Set the integration time for one measurement; the pulse length "T" is determined by PS_ITB		5:4	0x0 (0b00)	1 T (d	efault)
De	IT				0x1 (0b01)	2 T	
FG					0x2 (0b10)	4 T	
					0x3 (0b11)	8 T	
					0x0 (0b00)	1 pulse	(default)
PS	MPS	Set the number	of infrared signal	3:2	0x1 (0b01)	2 pulses	
F3_	WF 3	pulses per m	neasurement	5.2	0x2 (0b10)	4 pu	llses
					0x3 (0b11)	8 pi	llses
De	ITB	Sot the pulse lon	gth "T" for PS_IT	1	0x0 (0b0)	T = 25 με	s (default)
P3_		Set the pulse left	901 I 101 F3_11	I	0x1 (0b1)	T = 5	50 µs
	GAIN	Sat the gain	of the ADC	0	0x0 (0b0)	x 1 gain	(default)
P3_0		Set the gain		U	0x1 (0b1)	x 2	gain

TABLE 7 -	REGISTER	NAME: PS_C	ONF2_H				
Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
Res	erved	PS_SENS	PS_OFFSET	Reserved		PS_CURRENT	
COMMAND C	ODE					0x01	
Bit M	Name	Fu	inction	Bit	Value	Descr	ription
Res	erved	Re	eserved	15 : 14	0x0 (0b00)	Should be l	kept default
	SENG	Sat the same	itivity of the ADC	13	0x0 (0b0)	Normal sensi	tivity (default)
F3_	SENS	Set the sensitivity of the ADC		13	0x1 (0b1)	High sensitivity	
	FFSET	Enable / disable the internal crosstalk cancellation		12	0x0 (0b0)	Disable (default)	
F3_0	IT SET			12	0x1 (0b1)	Enable	
Res	erved	Re	eserved	11	0x0 (0b0)	Should be l	kept default
					0x0 (0b000)	7 mA (default)	
					0x1 (0b001)	9 mA	
					0x2 (0b010)	11 mA	
	JRRENT	Sat the VCS	EL driving current	10:8	0x3 (0b011)	12 mA	
F3_00		Set the VCS		10.0	0x4 (0b100)	15	mA
					0x5 (0b101)	17	mA
					0x6 (0b110)	19 mA	
					0x7 (0b111)	20 mA	

Rev. 1.2, 16-Nov-2023

14



Vishay Semiconductors

VCNL36828P

Document Number: 80306

TABLE 8 - MAX	KIMUM BIT RESO	LUTION AND DI	GITAL OUTPUT C	OUNTS				
BIT N	NAME	PS_IT = 1T	PS_IT = 2T	$PS_IT = 4T$	PS_IT = 8T			
PS HD = 0 (12 bit)	PS_GAIN = 0 (x1 gain)	12 bit / 4095 counts						
PS_HD = 0 (12 bit)	PS_GAIN = 1 (x2 gain)							
$D_{2}^{2} = 1 (16 \text{ bit})$	PS_GAIN = 0 (x1 gain)	12 bit / 4095 counts	13 bit / 8191 counts	14 bit / 16 383 counts	15 bit / 32 767 counts			
PS_HD = 1 (16 bit)	PS_GAIN = 1 (x2 gain)	13 bit / 8191 counts	14 bit / 16 383 counts	15 bit / 32 767 counts	16 bit / 65 535 counts			

TABLE 9 - REGISTER NAME: PS_CONF3_L											
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0				
Res	erved	PS_TRIG	PS_MODE		Rese	erved					
COMMAND C	OMMAND CODE 0x02										
Bit I	Name	Fu	nction	Bit	Value	Desci	ription				
Res	erved	Re	served	7:6	0x0 (0b00)	Should be kept default					
PS TRIG		Set the active force mode trigger; This bit will be reset to 0 after		5	0x0 (0b0)	Off (d	efault)				
F3_		the measurement cycle		5	0x1 (0b1)	Trigger					
	MODE	Set the mea	surement mode	4	0x0 (0b0)	Auto mode (default)					
PS_MODE		of th	e sensor	4	0x1 (0b1)	Active force mode					
Res	erved	Re	served	3:0	0x0 (0b0000)	Should be kept default					

TABLE 10	- REGISTER	NAME: PS_	CONF3_H				
Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
PS_SP	PERIOD	Reserved		PS_SC		Rese	erved
COMMAND C	ODE					0x02	
Bit N	lame	Fu	Inction	Bit	Value	Desci	ription
		0x0 (0b00)		(follow PS_PE	short period ERIOD setting) ault)		
PS_SP	PS_SPERIOD		Set the short measurement period		0x1 (0b01)	6.25 ms, which translates in 160 measurements/s	
					0x2 (0b10)		n translates into rements/s
					0x3 (0b11)	25 ms, which translates into 40 measurements/s	
Rese	erved	Re	eserved	13	0x0 (0b0)	Should be	kept default
	20	Enabl	e / disable	10, 10	0x0 (0b000))) Disable (default)	
	_SC		ht cancellation	12 : 10	0x7 (0b111)	Ena	able
Rese	erved	Re	eserved	9:8	0x0 (0b00)	Should be	kept default



VCNL36828P



www.vishay.com

Vishay Semiconductors

TABLE 11	TABLE 11 - REGISTER NAME: PS_THDL										
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0				
PS_THDL_L											
Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8				
	PS_THDL_H										
COMMAND C	ODE					0x03					
Bit N	Bit Name Function			Bit	Value	Desci	ription				
PS_T	PS_THDL_L		shold interrupt value	7:0	0 to 65 535		byte				
PS_THDL_H		Set the low threshold interrupt value		15 : 8	0 10 05 555	High byte					

TABLE 12	TABLE 12 - REGISTER NAME: PS_THDH										
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0				
PS_THDH_L											
Bit 15 Bit 14 Bit 13 Bit 12 Bit 11 Bit 10 Bit 9 Bit 8											
	PS_THDH_H										
COMMAND C	ODE					0x04					
Bit N	lame	Fu	Inction	Bit	Value	Desc	ription				
PS_THDH_L Set the high threshold		7:0		0 to 65 535	Low byte						
PS_THDH_H		Set the high the	eshold interrupt value	15 : 8	0 10 05 555	High byte					

TABLE 13	- REGISTER	NAME: PS_	CANC							
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0			
PS_CANC_L										
Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8			
	Reserved PS_CANC_H									
COMMAND C	ODE					0x05				
Bit I	Name	Fu	inction	Bit	Value	Desci	ription			
PS_C	PS_CANC_L Set the offset			7:0	0 to 4095	Low byte				
PS_C	PS_CANC_H count cancellation value		cellation value	11:8	0 10 4095	High byte				
Res	Reserved Reserved			15 : 12	0x0 (0b0000)	Should be	kept default			

TABLE 14	TABLE 14 - REGISTER NAME: PS_DATA										
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0				
PS_DATA_L											
Bit 15 Bit 14 Bit 13 Bit 12 Bit 11 Bit 10 Bit 9 Bit 8											
	PS_DATA_H										
COMMAND C	ODE					0xF8					
Bit N	Bit Name Function			Bit	Value	Descr	iption				
PS_DATA_L Read the proximity output data		7:0	0 to 65 535		byte						
PS_DATA_H		nead the pro	xinity output data	15 : 8	0 10 05 555	High byte					

Rev. 1.2, 16-Nov-2023

Document Number: 80306

VCNL36828P

Vishay Semiconductors

TABLE 15	- REGISTER	R NAME: INT	FLAG				
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
		•	Reserv	ed	•	•	
Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
	Reserved		PS_SPFLAG	Res	erved	PS_IF_CLOSE	PS_IF_AWAY
COMMAND CODE						0xF9	
Bit I	Name	Fu	Inction	Bit	Value	Desci	ription
Res	erved	Re	eserved	7:0	0x00 - 0xFF (0b00000000 - 0b1111111)	Should be	kept default
Res	erved	Re	Reserved		0x0 (0b000)	Should be l	kept default
PS SPFLAG		Read the sunlight protection mode		12	0x0 (0b0)		otection mode event flag
10_0		interrupt event flag			0x1 (0b1)	Sunlight protection mode interrupt event flag	
Res	erved	Re	eserved	11 : 10	0x0 (0b00)	Should be	kept default
		Read the high	Read the high threshold crossing		0x0 (0b0)		hold crossing event flag
PS_IF_CLOSE		interrupt event flag		9	0x1 (0b1)	High threshold crossing interruevent flag	
	PS_IF_AWAY		threshold crossing	8	0x0 (0b0)	No low thres interrupt	hold crossing event flag
F3_IF			ot event flag	o	0x1 (0b1)	Low threshold crossing interre event flag	

TABLE 16 - REGISTER NAME: VCNL36828P_ID											
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0				
			VCNL36828	P_ID_L							
Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10 Bit 9 Bit 8						
	VCNL36828P_ID_H										
COMMAND CODE 0xFA											
Bit Name Function				Bit	Value	Description					
					0x28 (0b00101000)		with a ess of 0x60				
VCNL36828P_ID_L VCNL36828P_ID_H		Read the device ID		7:0	0x29 (0b00101001)	Device slave addre	with a ess of 0x51				
				15 : 8	0x01 (0b0000001)	Should be l	kept default				



THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000





PACKAGE INFORMATION in millimeters

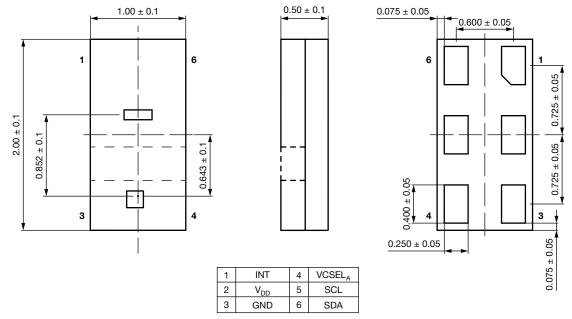


Fig. 16 - VCNL36828P Package Dimensions

RECOMMENDED LAYOUT PAD INFORMATION in millimeters

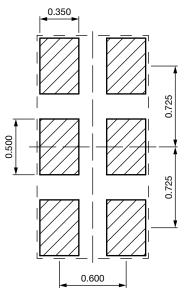


Fig. 17 - VCNL36828P PCB Layout Footprint



RECOMMENDED INFRARED REFLOW

Soldering conditions which are based on J-STD-020C

IR REFLOW PROFILE CONDITION			
PARAMETER	CONDITIONS	TEMPERATURE	TIME
Peak temperature		260 °C + 5 °C / - 5 °C (max.: 265 °C)	10 s
Preheat temperature range and timing		150 °C to 200 °C	60 s to 180 s
Timing within 5 °C to peak temperature		-	10 s to 30 s
Timing maintained above temperature / time		217 °C	60 s to 150 s
Timing from 25 °C to peak temperature		-	8 min (max.)
Ramp-up rate		3 °C/s (max.)	-
Ramp-down rate		6 °C/s (max.)	-

Recommend Normal Solder Reflow is 235 °C to 265 °C

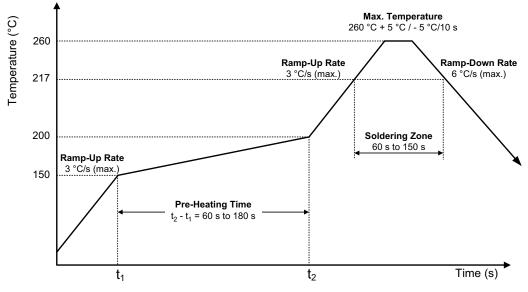
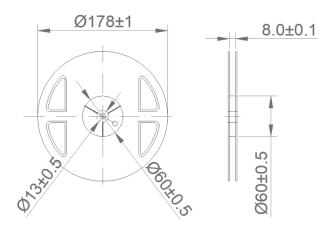
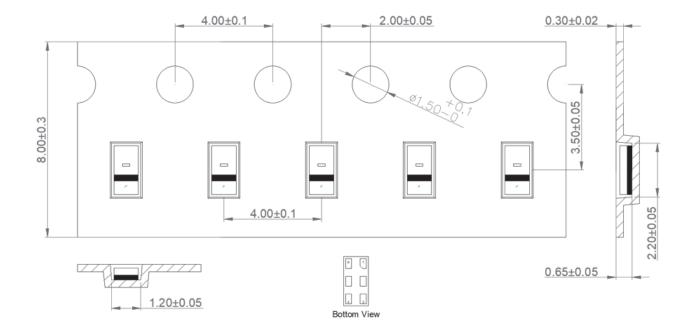


Fig. 18 - VCNL36828P Solder Reflow Profile Chart



TAPE PACKAGING INFORMATION in millimeters







Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

© 2024 VISHAY INTERTECHNOLOGY, INC. ALL RIGHTS RESERVED

Revision: 01-Jul-2024

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Proximity Sensors category:

Click to view products by Vishay manufacturer:

Other Similar products are found below :

 70.340.1028.0
 70.360.2428.0
 8027AL20NL2CPXX
 9221350022
 922AA2W-A9P-L
 GL-12F-C2.5X10(LOT3)
 972AB3XM-A3P-L
 PS3251

 980659-1
 E2E2-X5M41-M4
 E2E-X14MD1-G
 E2E-X2D1-G
 E2E-X4MD1-G
 E2E-X5E1-5M-N
 E2E-X5Y2-N
 EH-302
 EI3010TBOP

 MS605AU
 EP175-32000
 IC08ANC15PO-K
 IFRM04P1513/S35L
 IFRM06P1703/S35L
 IFRM08P1501/S35L
 IFRM12N17G3/L

 IFRM12P3502/L
 IFRM12P37G1/S14L
 ILFK12E9189/I02
 ILFK12E9193/I02
 IMM2582C
 OISN-013
 25.332.0653.1
 25.352.0653.0

 25.352.0753.0
 25.523.3253.0
 9151710023
 922AA1HI-A4P-L
 922AA2XM-B9P-L
 922FS0.8-H4P-G-020
 922FS1.5C-A4P-Z774

 SC606ABV0S30
 SM851A1200FP
 F3S-A162-U
 GL-12F-C2X10(LOT10)
 GL-8HIBX10
 QT-08L
 RDS-DIN3-PA-D1
 34.110.0010.0
 3U02

 TL-C2MF1-M3-E4
 TLX5C1GE
 I
 SU02
 SU02
 SU02
 SU02
 SU02